

### FEATURES

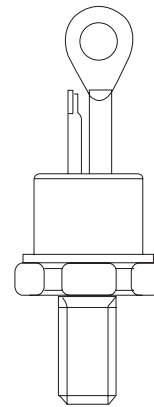
- 1). Improved glass passivation for high reliability and exceptional stability at high temperature
- 2). High di/dt and dv/dt capabilities
- 3). Standard package
- 4). Low thermal resistance
- 5). Metric threads version available
- 6). Types up to 1200V  $V_{DRM}/V_{RRM}$

### TYPICAL APPLICATIONS

- 1). Medium power switching
- 2). Phase control applications
- 3). Can be supplied to meet stringent military, aerospace and other high-reliability requirements

### MAJOR RATINGS AND CHARACTERISTICS

Parameters		K10RIA	Unit
$I_{F(AV)}$		10	A
	@ $T_C$	85	°C
$I_{F(RMS)}$		25	A
	@ 50Hz	225	A
$I_{FSM}$	@ 60Hz	240	A
	@ 50Hz	255	A <sup>2</sup> s
$I^2t$	@ 60Hz	233	A <sup>2</sup> s
		100 to 1200	V
$V_{DRM}/V_{RRM}$			
$T_q$	typical	110	μs
$T_J$		- 65 to 125	°C



### ELECTRICAL SPECIFICATIONS

#### 1). Voltage Ratings

Type number	Voltage Code	$V_{DRM}/V_{RRM}$ , maximum repetitive peak reverse voltage *(1)	$V_{RSM}$ , maximum non-repetitive peak reverse voltage *(2)	$I_{DRM}/I_{RRM}$ max. @ $T_J = T_J$ max
		V	V	mA
K10RIA	10	100	150	10
	20	200	300	
	40	400	500	
	60	600	700	
	80	800	900	
	100	1000	1100	
	120	1200	1300	

\*(1) Units may be broken over non-repetitively in the off-state direction without damage, if di/dt does not exceed 20A/μs

\*(2) For voltage pulses with  $t_p \leq 5ms$

2). Forward Conduction

Parameters		K10RIA	Unit	Conditions		
$I_{T(AV)}$	Max. average forward current	10	A	180° conduction, half sine wave		
	@ Case temperature	85	°C			
$I_{T(RMS)}$	Max. RMS forward current	25	A			
$I_{TSM}$	Max. peak, one-cycle forward, non-repetitive surge current	225	A	t = 10ms	No voltage	Sinusoidal half wave, Initial $T_J = T_J \text{ max.}$
		240		t = 8.3ms	reapplied	
		190		t = 10ms	100% $V_{RRM}$	
		200		t = 8.3ms	reapplied	
$I^2t$	Maximum $I^2t$ for fusing	255	$A^2s$	t = 10ms	No voltage	Sinusoidal half wave, Initial $T_J = T_J \text{ max.}$
		233		t = 8.3ms	reapplied	
		180		t = 10ms	100% $V_{RRM}$	
		165		t = 8.3ms	reapplied	
$I^2\sqrt{t}$	Maximum $I^2\sqrt{t}$ for fusing	2550	$A^2\sqrt{s}$	t = 0.1 to 10ms, no voltage reapplied		
$V_{T(TO)1}$	Low level value of threshold voltage	1.10	V	$(16.7\% \times \pi \times I_{F(AV)} < I < \pi \times I_{F(AV)})$ , $T_J = T_J \text{ max.}$		
$V_{T(TO)2}$	High level value of threshold voltage	1.39	V	$(I > \pi \times I_{F(AV)})$ , $T_J = T_J \text{ max.}$		
$r_{t1}$	Low level value of forward slope resistance	24.3	$m\Omega$	$(16.7\% \times \pi \times I_{F(AV)} < I < \pi \times I_{F(AV)})$ , $T_J = T_J \text{ max.}$		
$r_{t2}$	High level value of forward slope resistance	16.7	$m\Omega$	$(I > \pi \times I_{F(AV)})$ , $T_J = T_J \text{ max.}$		
$V_{TM}$	Max. forward voltage drop	1.75	V	$I_{pk} = 32A$ , $T_J = 25^\circ C$ , $t_p = 10ms$ sine pulse		
$I_H$	Maximum holding current	130	mA	$T_J = 25^\circ C$ , anode supply 12V resistive load		
$I_L$	Typical latching current	200	mA			
di/dt	Max. rate of rise of turned-on current			$T_J = T_J \text{ max.}$ , $V_{DM} = \text{rated } V_{DRM}$ Gate pulse = 20V,		
	$V_{DRM} \leq 600V$	200	$A/\mu s$	15Ω, $t_p = 6 \mu s$ , $t_r = 0.1 \mu s \text{ max.}$		
	$V_{DRM} \leq 800V$	180		$I_{TM} = (2x \text{ rated di/dt}) A$		
	$V_{DRM} \leq 1000V$	160				
	$V_{DRM} \leq 1600V$	150				
$t_{gt}$	Typical turn-on time	0.9		$T_J = 25^\circ C$ , at = rated $V_{DRM}/V_{RRM}$ , $T_J = 125^\circ C$		
$t_{rr}$	Typical reverse recovery time	4		$T_J = T_J \text{ max.}$ , $I_{TM} = I_{T(AV)}$ , $t_p > 200 \mu s$ , $di/dt = -10A/\mu s$		
$t_q$	Typical turn-off time	110	$\mu s$	$T_J = T_J \text{ max.}$ , $I_{TM} = I_{T(AV)}$ , $t_p > 200 \mu s$ , $V_R = 100V$ , $di/dt = -10A/\mu s$ , $dv/dt = 20V/\mu s$ linear to 67% $V_{DRM}$ , gate bias 0V-100W		
dv/dt	Max. critical rate of rise of	100		$T_J = T_J \text{ max.}$ linear to 100% rated $V_{DRM}$		
	off-state voltage	300 (*)		$T_J = T_J \text{ max.}$ linear to 67% rated $V_{DRM}$		

(\*)  $t_q = 10 \mu s$  sup to 600V,  $t_q = 30 \mu s$  up to 1600V available on special request.

(\*\*) Available with:  $dv/dt = 1000V/\mu s$ , to complete code add S90 i.e. 16RIA120S90.

3). Triggering

Parameters		K10RIA		Unit	Conditions
$P_{GM}$	Maximum peak gate power	8.0		W	$T_J = T_J \text{ max.}$
$P_{G(AV)}$	Maximum average gate power	2.0			
$I_{GM}$	Max. peak positive gate current	1.5		A	$T_J = T_J \text{ max.}$
$-V_{GM}$	Maximum peak negative gate voltage	10		V	$T_J = T_J \text{ max.}$
$I_{GT}$	DC gate current required to trigger	90	60	mA	$T_J = -65^\circ\text{C}$ Max. required gate trigger current/ voltage are the lowest value which will trigger all units 6V anode-to- cathode applied $T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$
		35			
		3.0			
$V_{GT}$	DC gate voltage required to trigger	2.0	2.0	V	$T_J = -65^\circ\text{C}$ $T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$
		1.0			
		1.0			
$I_{GD}$	DC gate current not to trigger	2.0		mA	$T_J = T_J \text{ max.}, V_{DRM} = \text{rated value}$
$V_{GD}$	DC gate voltage not to trigger	0.2		V	$T_J = T_J \text{ max.}$ Max. gate current/ voltage not to trigger is the max. value which. will not trigger any unit with rated $V_{DRM}$ anode-to-cathode applied $V_{DRM} = \text{rated value}$
$T_J$	Max. operating temperature range	- 65 to 125		$^\circ\text{C}$	
$T_{stg}$	Max. storage temperature range	- 65 to 125		$^\circ\text{C}$	
$R_{thJC}$	Max. thermal resistance, junction to case	1.85		K/W	DC operation
$R_{thCS}$	Max. thermal resistance, case to heatsink	0.35		K/W	Mounting surface, smooth, flat and greased
T	Mounting torque	to nut	to device		Lubricated threads (Non-lubricated threads)
		20(27.5)	25	lbf-in	
		0.23(0.32)	0.29	kgf.m	
		2.3(3.1)	2.8	Nm	
wt	Approximate weight	14 (0.49)		g (oz)	See Outline Table
	Case style	TO-48			

$\Delta R_{thJC}$  Conduction

(The following table shows the increment of thermal resistance  $R_{thJC}$  when devices operate at different conduction angles than DC)

Conduction angle	Sinusoidal conduction	Rectangular conduction	Units	Conditions
180°	0.44	0.32	K/W	$T_J = T_J \text{ max.}$
120°	0.53	0.56		
90°	0.68	0.75		
60°	1.01	1.05		
30°	1.71	1.73		

**PERFORMANCE CURVES FIGURE**

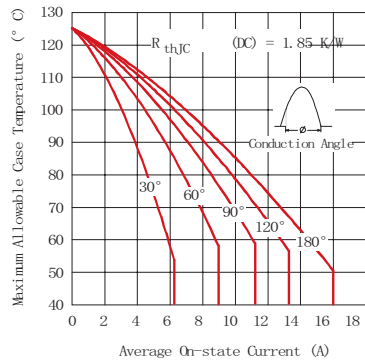


Fig. 1 - Current Ratings Characteristic

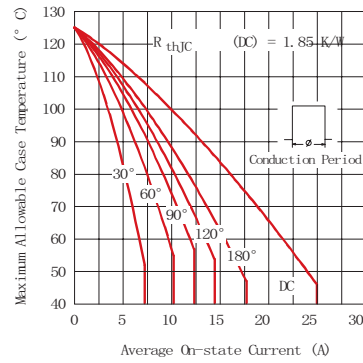


Fig. 2 - Current Ratings Characteristic

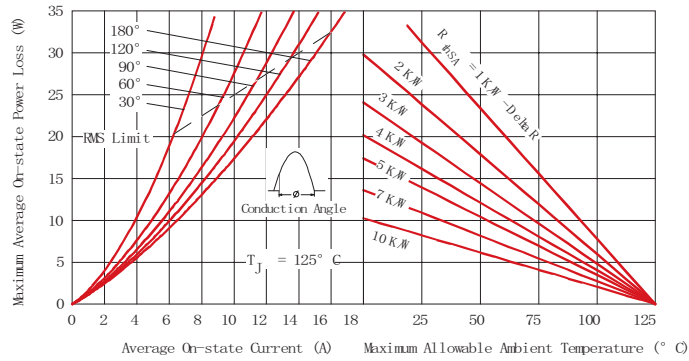


Fig. 3 - On-state Power Loss Characteristics

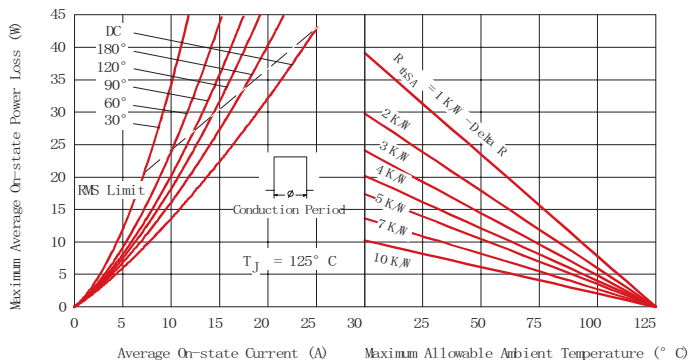


Fig. 4 - On-state Power Loss Characteristics

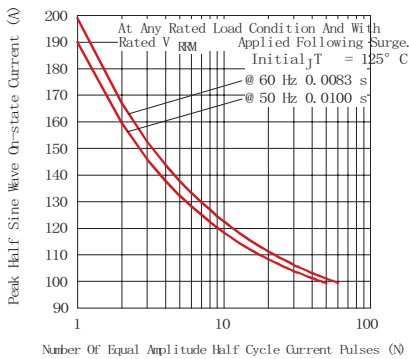


Fig. 5 - Maximum Non-Repetitive Surge Current

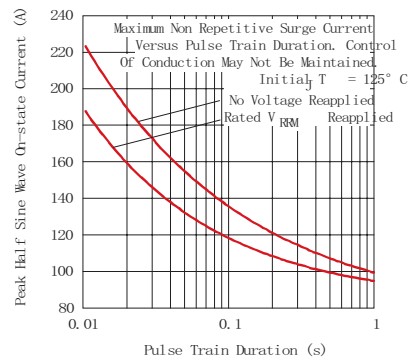


Fig. 6 - Maximum Non-Repetitive Surge Current

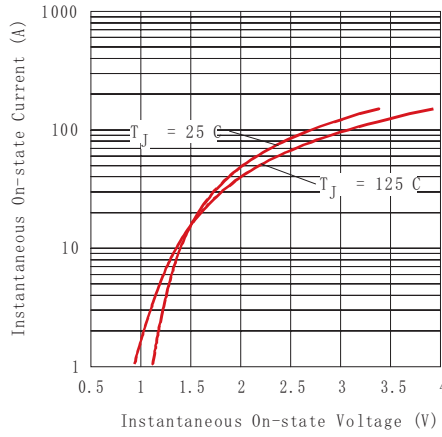


Fig. 7 - Forward Voltage Drop Characteristics

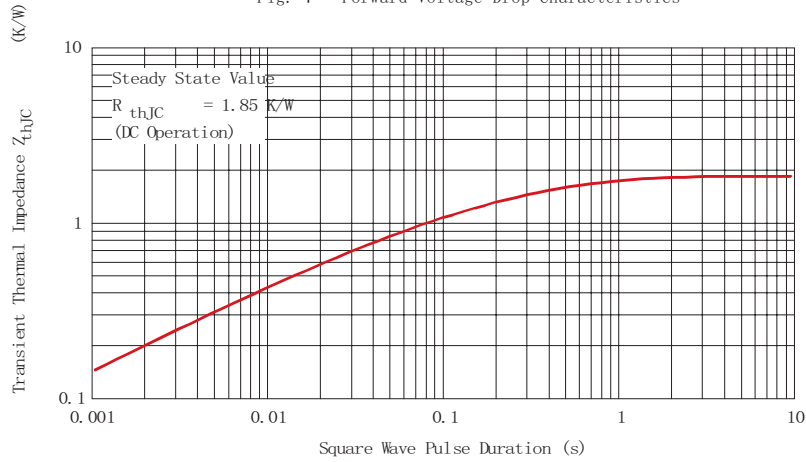


Fig. 8 - Thermal Impedance  $Z_{thJC}$  Characteristics

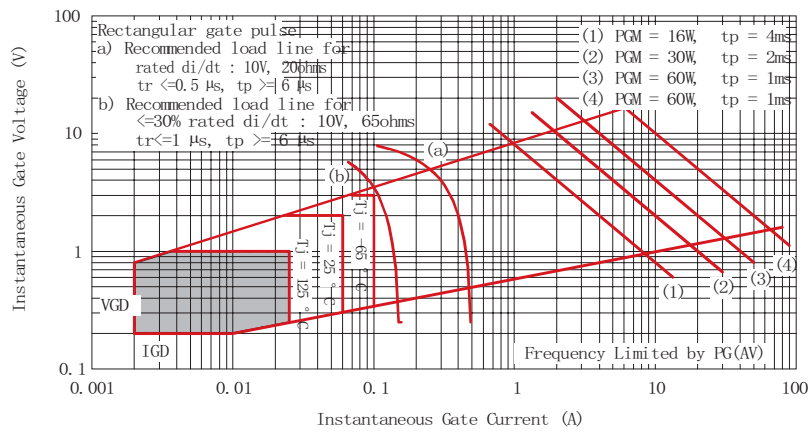
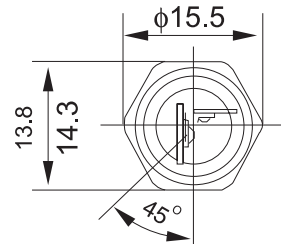
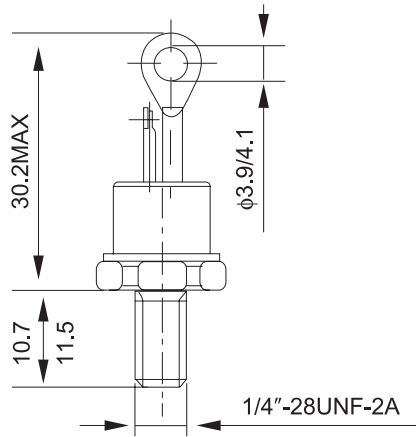


Fig. 9 - Gate Characteristics

**OUTLINE**



\*FOR METRIC DEVICE: M6×1

**Case Style TO-48**

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